

Introduction:

Resin bond diamond grinding plates are used on floor grinding machines to polishing concrete, terrazzo and stone floor. The HTC plugging design makes the installation very easy and convenient.

Features:

1. Stable performance and long lifespan.
2. Suitable for EZ-change system of HTC grinding head,very easy and convenient.

Specifications:

The followings are the normal specifications of our resin bond diamond grinding plates:

Product Name	Segment Material	Segment Shape	Segment No.	Grit	Applications
HTC Resin Bond Diamond Grinding Plate/Block	Resin Diamond	Cylinder	5	50#, 100#, 200#, 400#, 800#, 1500#, 3000#	Concrete Terrazzo Stone Floor

The above specifications are for reference, other specifications can be ordered by customers.